د الله المعادد و المعادد و

Fig.1

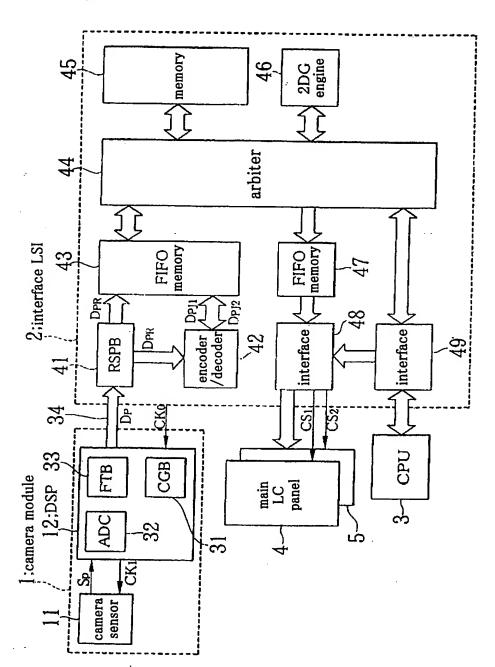


Fig.2

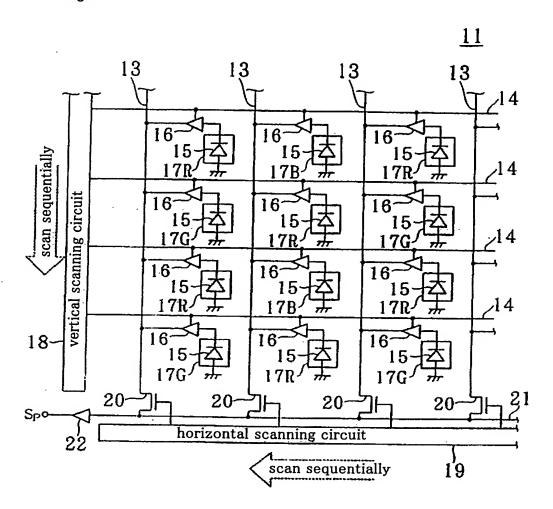


Fig.3

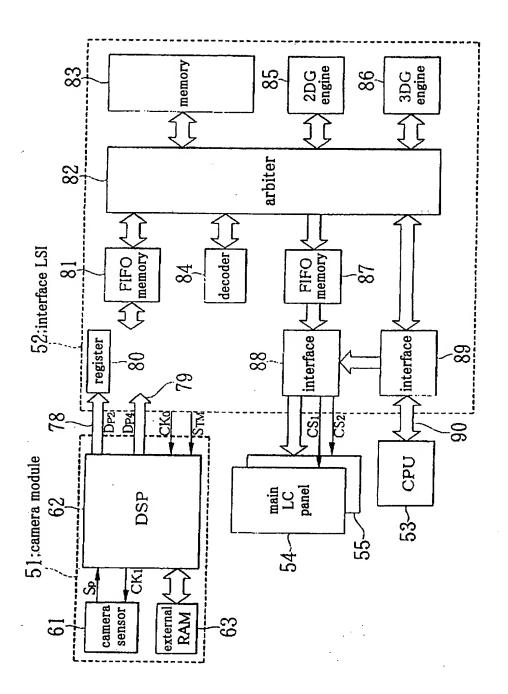


Fig.4

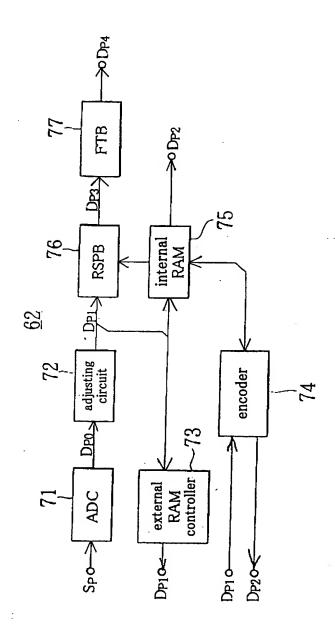


Fig.5

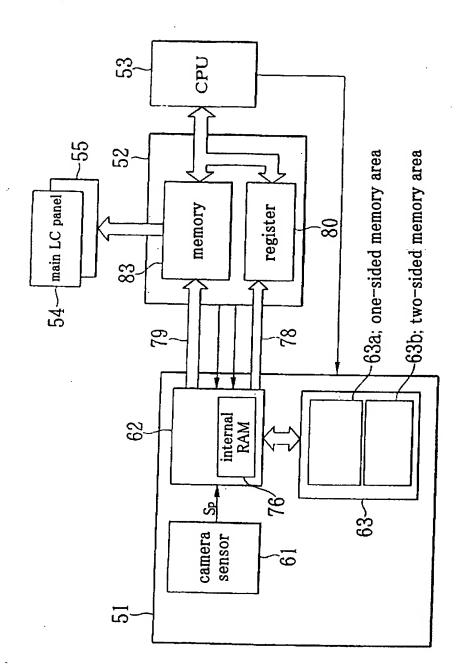
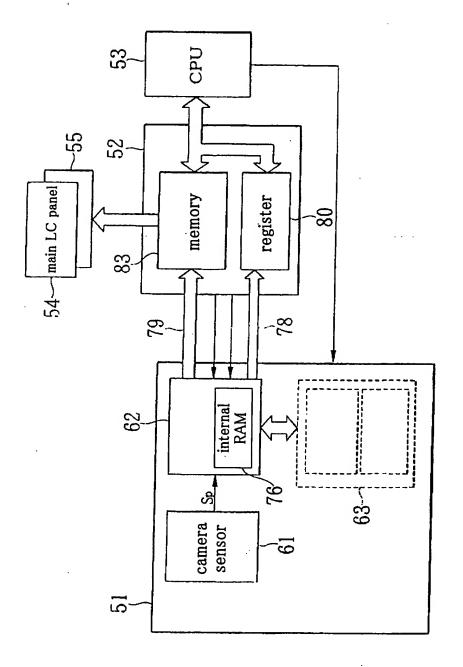


Fig.6



mode		camera module		IO I columbas
	the number of bits	the number of bits role of internal RAM role of external RAM	role of external RAM	illeriace LSI
mobile camera mode	320×240	compression coding processing buffer frame buffer data buffer	inactive state	operate on 48MHz clock supply 12MHz clock camera module
digital camera mode	1280×960	compression coding processing buffer	frame buffer data buffer	operate on 48MHz clock supply 48MHz clock to camera module

Fig.8

mode	the number of bits	circuit	prior art	embodiment
mobile camera	320×240	camera module	input about 48MHz clock	input about 12MHz clock
mode	320 \ 240	interface LSI	operate on about 200MHz clock	operate on about 48MHz clock
digital camera mode	1280×960	camera module	input about 48MHz clock	input about 48MHz clock
		interface LSI	operate on about 200MHz clock	operate on about 48MHz clock

Fig.9

	the number of gates			
	prior art	embodiment		
camera module	about 2,000	about 2,200		
interface LSI	about 3,000	about 500		
total	about 5,000	about 2,700		